

OPTICAL PICKUP DEVICE

Abstract

A method for assembling an optical disk apparatus involves disposing first and second short-cutting terminals at different faces of a housing and in parallel with a laser diode of the apparatus. In a first state of assembling, the first short-cutting terminal is shorted by a solder applied thereon. Thereafter, the apparatus is inspected in a second state of assembling in which the solder is removed from the first short-cutting terminal. After inspection, the second short-cutting terminal is shorted by a solder applied thereon. Subsequently, the solder on the second short-cutting terminal is removed.

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